IPC ASSOCIATION CONNI ELECTRONICS INDUS	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					erials and N	Afg Informat	ion		
upplier Info	ormation														
Company name* Company				pany unique ID			Unique ID Authority				Respon	Response Date*			
nsemi											2025-0	2025-07-07			
Contact Name			Title - Contact			I	Phone - Contact*				Email	Email - Contact*			
Product-Env-S	Stewards		Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
uthorized Rep	presentative*	Title - Representative			I	Phone - Representative*				Email	Email - Representative*				
Product-Env-S	Stewards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
Requ	uester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Versio	n	Manufacturing Site		Weight*	UOM	Unit Type	
	ESD8006MUTAG Low cap ESD p		Low cap ESD prote	ection		2025-07-07					14.76	mg	Each		
Ianufacturi	ing Proccess Inform	ation													
Term	Terminal Plating / Grid Array Material Terminal Base Alloy J-STD			STD-020 MSL	Rating	ing Peak Process Body Temperature Max Time at Peak					ature Num	ber of Reflow Cy	cles		
Matte Tin (Sn) - annealed		CU Alloy 1				260		C	30	seco	nds 3				
omments															
vel 1 - maximu	um time at peak tempera	ture during sol	dering is 10-3	30 seconds								·	·		
or more inforn	mation regarding materia	l composition	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Weight Unit of Measure		Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.98	mg Supplier		Silicon (Si)	7440-21-3		0.98	mg
Die Attach	0.18	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.036	mg
			Supplier	Silver (Ag)	7440-22-4		0.144	mg
Lead Frame	4.03	•	Supplier	Silver (Ag)	7440-22-4		0.0806	mg
			Supplier	Iron (Fe)	7439-89-6		0.0887	mg
			Supplier	Copper (Cu)	7440-50-8		3.8607	mg
Mold Compound-Black	8.09	mg		Epoxy Phenol Resin	proprietary data		0.7281	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		7.3619	mg
Plating	1.41	mg	Supplier	Tin (Sn)	7440-31-5		1.41	mg
Wire Bond	0.07	mg	Supplier	Palladium (Pd)	7440-05-3		0.0007	mg
			Supplier	Copper (Cu)	7440-50-8		0.0693	mg